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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Yongcai Wang, et al

PROCESS OF PRODUCING
MICROCAPSULES AND PRODUCT
THEREOF

Serial No. 10/764,411

Filed 23 January 2004

Group Art Unit: 1711

Examiner: Saira B. Raza

I hereby certify that this correspondence is being deposited today with the United States Postal Service as first class mail in an envelope addressed to Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Frieda Grinnell

Frieda Grinnell

November 28, 2005

Date

Commissioner for Patents
P.O. Box 1450
Alexandria, VA. 22313-1450

Sir:

**REQUEST FOR CORRECTION TO PATENT
APPLICATION PUBLICATION**

A material mistake has been discovered in the above-captioned Publication. The inventor, Peter D. Rollinson's name was listed incorrectly on the face of the Publication. Enclosed is a copy of the Assignment showing the correct spelling of his name.

Therefore, we are requesting a correction to the patent application Publication due to a United States Patent and Trademark Office error.

The Commissioner is hereby authorized to charge any fees in connection with this communication to Eastman Kodak Company Deposit Account No. 05-0225. **A duplicate copy of this letter is enclosed.**

Respectfully submitted,

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If the Examiner is unable to reach the Applicant(s) Attorney at the telephone number provided, the Examiner is requested to communicate with Eastman Kodak Company Patent Operations at (585) 477-4656.



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(54) PROCESS OF PRODUCING
MICROCAPSULES AND PRODUCT
THEREOF

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(57) ABSTRACT

This invention relates to a process for preparing microcapsules containing a hydrophobic liquid core material, the process comprising:

- (1) mixing an organic liquid phase which comprises the hydrophobic liquid core material with an aqueous phase comprising a stabilizer to form a premix;
- (2) homogenizing the premix by forcing the premix under pressure through a high pressure passage into a low pressure area to produce a microparticle dispersion, said microparticles having a mean size of greater than 1.0 micron,
- (3) adding an encapsulating material prior to step (4); and
- (4) curing the encapsulating material associated with the microparticles to form the microcapsules.

A S S I G N M E N T

For good and valuable consideration received, including salary or payment for the making of inventions, or employee benefits, I/we do hereby assign to Eastman Kodak Company, a New Jersey corporation having a principal place of business in Rochester, New York, its successors and assigns, the entire right, title and interest, including priority rights, in and to all of my/our inventions and improvements disclosed in an application for patent for

PROCESS OF PRODUCING MICROCAPSULES AND PRODUCT THEREOF

which is [check one]

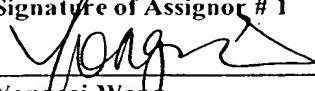
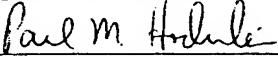
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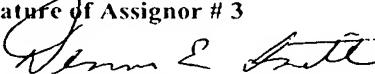
a provisional application for patent by:

an international application for patent by:

Assignor # 1: Yongcui Wang	Date 1/23/04
Assignor # 2: Paul M. Hoderlein	Date 1/23/04
Assignor # 3: Dennis E. Smith	Date 1/21/04
Assignor # 4: Peter D. Rollinson	Date 1/22/04

and [check one] about to be filed already filed as
in the United States Patent and Trademark Office, together with said application, and any corresponding or counterpart provisional or non-provisional application, and any divisional, continuation, substitute, reissue, re-examination application thereof, and any applications, including international applications, corresponding or being a counterpart thereto in whole or in part in the United States and all other countries. I/We do hereby acknowledge that I/we were subject to an obligation of assignment to Eastman Kodak Company with respect to the entire right, title and interest in and to said inventions at the time the inventions were made. I/We also do hereby assign to Eastman Kodak Company the entire right, title and interest in and to Letters Patent and similar protective rights granted on any of these applications, as well as the right to claim any applicable priority rights arising from any of these applications under the terms of any applicable conventions, treaties, statutes or regulations. I/We agree that any of these applications, at Eastman Kodak Company's sole discretion, may be filed and issued in the name of Eastman Kodak Company or its designee. I/We agree to execute such documents which in the judgment of Eastman Kodak Company may be necessary to obtain any such patents and similar protective rights and to maintain the title thereto in Eastman Kodak Company or its designee. I/We further agree that, upon request, but without out-of-pocket expense to myself/ourselves, I/we shall furnish to Eastman Kodak Company or its designee any data, information, exhibits, memoranda, or other evidence in my/our possession relating to any of said inventions or improvements and shall testify in any ex parte or inter partes legal or administrative proceedings relating thereto. I/We authorize and request issuance of all Letters Patent and similar protective rights that may be granted on any of these applications, to the extent that and in such manner as such issuance shall be requested by Eastman Kodak Company or its designee. This document shall be governed, construed and interpreted in all respects in accordance with the laws of the State of New York, USA.

Signature of Assignor # 1  Yongcui Wang Date: 1/23/04 Witnessed: <u>Freda DarTajar</u>	Witness Address, if other than Eastman Kodak Company, Rochester, NY 14650
Signature of Assignor # 2  Paul M. Hoderlein Date: 1/23/04 Witnessed: <u>Freda DarTajar</u>	Witness Address, if other than Eastman Kodak Company, Rochester, NY 14650

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Date: 1/21/04	
Witnessed: 	
Signature of Assignor # 4  Peter D. Rollinson	Witness Address, if other than Eastman Kodak Company, Rochester, NY 14650
Date: 1/22/04	
Witnessed: 	